Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

IM - B Relay

- **Minimum board-space 60mm²**
- **Slim line 10x6mm (0.39x0.24") and low profile 5.65mm (0.222")**
- **Switching power 60W/62.5VA**
- **Switching voltage 220VDC/250VAC**
- **Switching current 2A**
- **Bifurcated contacts**
- **High mechanical shock resistance**

IM_AB

Typical applications
Telecommunication, access and transmission equipment, optical network terminals, modems, office and business equipment, consumer electronics, measurement and Test equipment, industrial control, medical equipment

Approvals

UL 508 File No. E 111441
Technical data of approved types on request

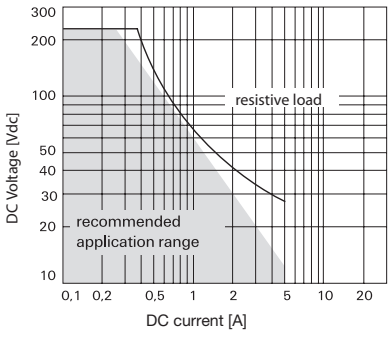
Contact Data

Contact arrangement	1 form A (1 NO)
Max. switching voltage	220VDC, 250VAC
Rated current	2A
Limiting continuous current	2A
Switching power	60W, 62.5VA
Contact material	PdRu Au covered
Contact style	twin contacts
Minimum switching voltage	100µV
Initial contact resistance	<100mΩ at 10mA/30mV
Thermoelectric potential	<10µV
Operate time	typ. 1ms, max. 3ms
Release time	
without diode in parallel	typ. 1ms, max. 3ms
with diode in parallel	typ. 3ms, max. 5ms
Bounce time max.	typ. 1ms, max. 5ms
Electrical endurance	
at contact application 0 (≤ 30mV / ≤ 10mA)	min. $2.5x10^6$ operations
cable load open end	min. $2.0x10^6$ operations
resistive, 125VDC / 0.24A - 30W	min. $5x10^5$ operations
resistive, 220 VDC / 0.27A - 60W	min. $1x10^5$ operations
resistive, 250VAC / 0.25A - 62.5VA	min. $1x10^5$ operations
resistive, 30VDC / 1A - 30W	min. $5x10^5$ operations
resistive, 30VDC / 2A - 60W	min. $1x10^5$ operations

Contact data (continued)

UL contact rating	30VDC, 2A, 60W, NO only
	110VDC, 0.3A, 33W
	220VDC, 0.27A, 60W
	125VAC, 0.5A, 62.5W
	250VAC, 0.25A, 62.5W
Mechanical endurance	10^8 operations

Max. DC load breaking capacity



Coil Data

Magnetic system	monostable, bistable
Coil voltage range	1.5 to 24VDC
Max. coil temperature	125°C
Thermal resistance	<150K/W

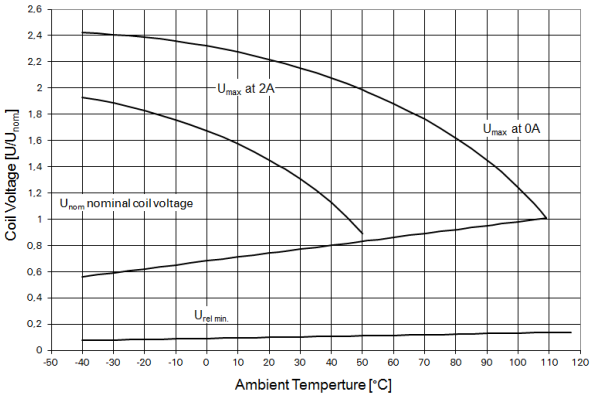
Coil versions, standard version, monostable, 1 coil

Coil code	Rated voltage VDC	Operate voltage VDC	Release voltage VDC	Coil resistance Ω±10%	Rated coil power mW
01	3.0	2.25	0.30	64	140
02	4.5	3.38	0.45	145	140
03	5.0	3.75	0.50	178	140
06	12.0	9.00	1.20	1029	140

All figures are given for coil without pre-energization, at ambient temperature +23°C

Insulation C*

Coil operating range



high

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IM - B Relay (Continued)

dielectric version	
Initial dielectric strength	
between open contacts	2500Vrms
between contact and coil	3500Vrms
Initial surge withstand voltage	
between open contacts	3500V
between contact and coil	4900V
Initial insulation resistance	
between insulated elements	$>10^9\Omega$
Capacitance	
between open contacts	max. 1pF
between contact and coil	max. 2pF
between adjacent contacts	max. 2pF

*this relay contains SF6 (Sulfur hexafluoride, CAS number: 2551-62-4) for dielectric strength enhancement, SF6 is hermetically sealed in relay without leaks to air during normal application as recommended per the applicable product specification. It is clarified that the usage of SF6 in mini signal relay is not prohibited by related regulations. Please contact TE local sales or field engineer for further information and detailed material declaration.

RF Data

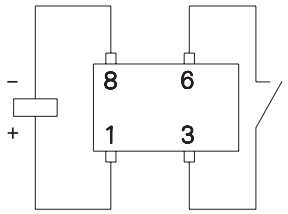
Isolation at 100MHz/900MHz	37.0dB/18.8dB
Insertion loss at 100MHz/900MHz	0.03dB/0.33dB
Voltage standing wave ratio (VSWR)	
at 100MHz/900MHz	1.06/1.49

Other Data

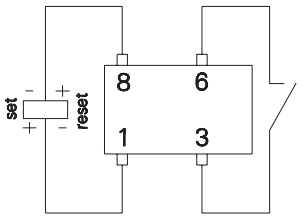
Material compliance: EU RoHS/ELV, China RoHS, REACH, Halogen content refer to the Product Compliance Support Center at www.te.com/customersupport/rohssupportcenter	
Ambient temperature	-40°C to +85°C
Thermal resistance	< 150K/W
Category of environmental protection	
IEC 61810	RT V - hermetically sealed
Degree of protection	
IEC 60529	IP 67, immersion cleanable
Vibration resistance (functional)	20g, 10 to 500Hz
Shock resistance (functional), half sinus 11ms	50g
Shock resistance (destructive), half sinus 0.5ms	500g
Weight	max. 0.75g
Resistance to soldering heat THT	
IEC 60068-2-20	265°C/10s
Resistance to soldering heat SMT	
IEC 60068-2-58	265°C/10s
Moisture sensitive level, JEDEC J-Std-020D	MSL3
Ultrasonic cleaning	not recommended
Packaging/unit	
THT version	tube/50pcs., box/1000 pcs.
SMT version	reel/1000 pcs., box/1000 or 5000 pcs.

Terminal assignment
TOP view on relay

IM-B, 1 form A (NO)

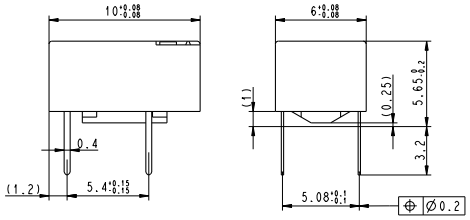


Contacts are shown in reset condition. Contact position might change during transportation and must be reset before use.

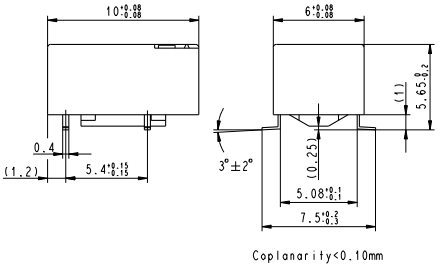


Dimensions

THT version Standard version

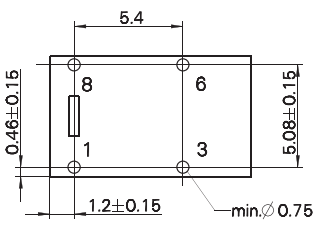


SMT version Gull wings

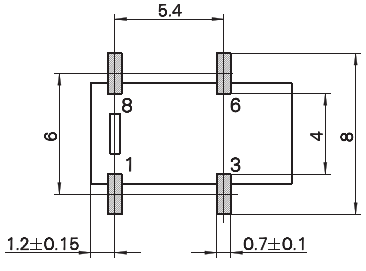


PCB layout
TOP view on component side of PCB

THT mounting holes



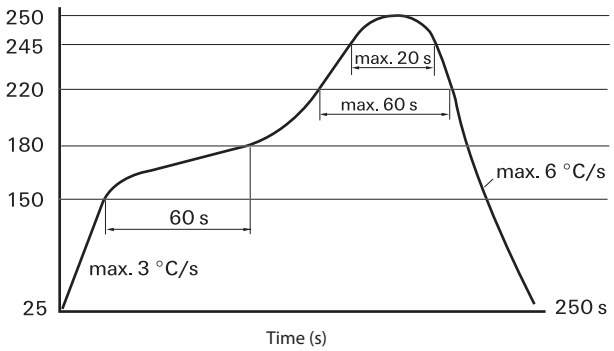
SMT - solder pads



IM - B Relay (Continued)

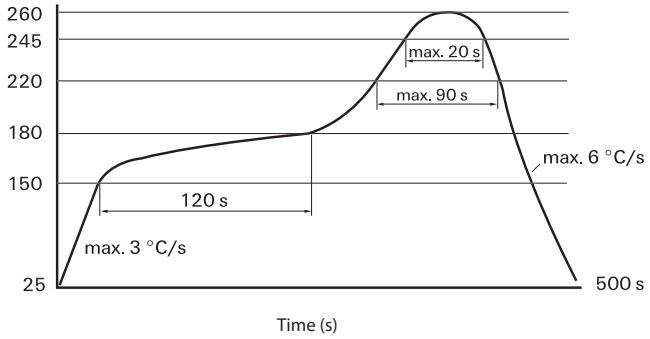
Processing Recommended soldering conditions

Soldering conditions according IEC 60058-2-58 and IPC/JEDEC J-STD-020D

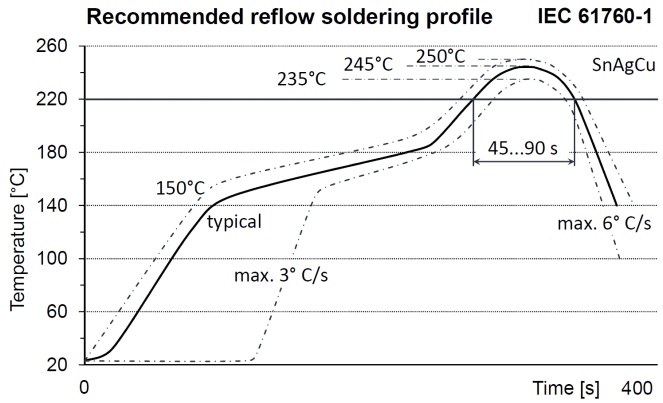


Infrared Soldering: temperature/ time profile (lead and housing peak temperature)

Resistance to soldering heat - Reflow profile



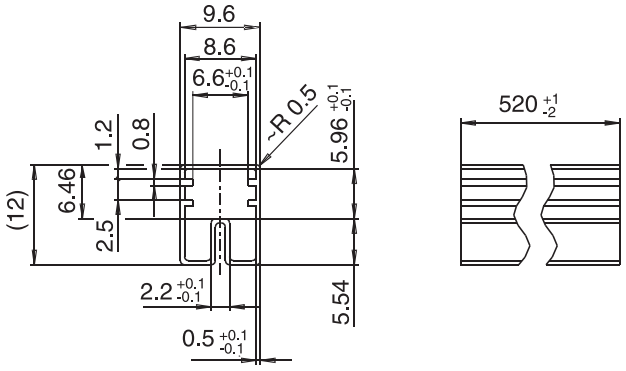
Recommended reflow soldering profile



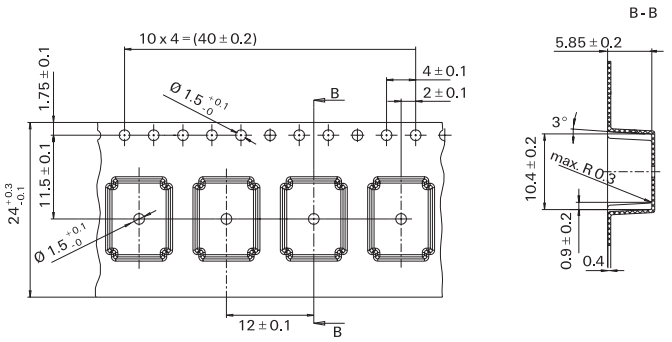
Vapor Phase Soldering: temperature/time profile (lead and housing peak temperature)

Packing

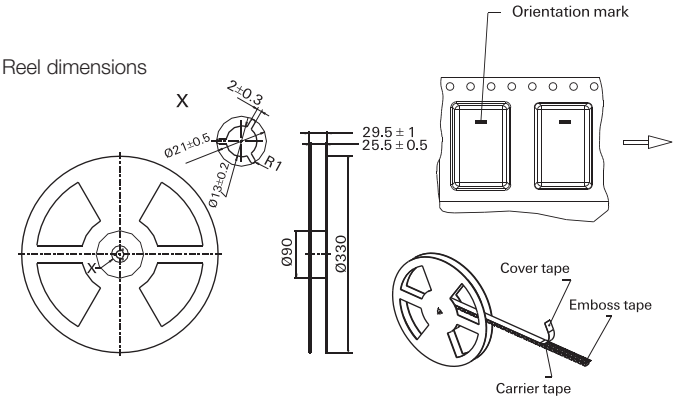
Tube for THT version
50 relays per tube, 1000 relays per box



Tape and reel for SMT version
1000 relays per reel, 1000 or 5000 relays per box



Reel dimensions



IM - B Relay (Continued)

Product code structure	Typical product code	IM	B	03		G	R

Type
IM Signal Relays IM Series IMA/IMB

Contact arrangement
B 1 form A, 1 NO

Coil
Coil code: please refer to coil versions table

Performance type
Blank Standard version **C** High Dielectric Version

Terminals
T THT - standard **G** SMT-gull wing

Packing
S Tube **R** Reel

Product code	Arrangement	Perf. type	Coil	Coil type	Terminals	Part number
IMB01CGR	1 form A,	High dielectric	3VDC	Monostable	SMT gull wing	1462041-1
IMB01CTS	1 NO				THT standard	1462041-4
IMB02CGR	contact		4.5VDC		SMT gull wing	1462041-2
IMB02CTS					THT standard	1462041-5
IMB03CGR			5VDC		SMT gull wing	1462041-7
IMB03CTS					THT standard	1462041-8
IMB04CGR			6VDC		SMT gull wing	1462041-9
IMB06CGR			12VDC			1462041-3
IMB06CTS					THT standard	1462041-6
IMB07CGR			24VDC		SMT gull wing	1-1462041-3
IMB07CTS					THT standard	1-1462041-4
IMB42CGR			4.5VDC	Bistable	SMT gull wing	1-1462041-6
IMB42CTS					THT standard	1-1462041-5